

4-11-02 mm  
J. A. B.

Docket No.: 50090-465

PATENT

**IN THE UNITED STATES PATENT AND TRADEMARK OFFICE**

In re Application of

Masaki WATANABE

Serial No.: Divisional of  
Appln. Serial No. 09/484,024

Group Art Unit: To be assigned

Filed: March 04, 2002

Examiner: To be assigned

For: PACKAGE FOR ACCOMMODATING ELECTRONIC PARTS, SEMICONDUCTOR DEVICE  
AND METHOD FOR MANUFACTURING PACKAGE

**PRELIMINARY AMENDMENT**

Commissioner for Patents  
Washington, DC 20231

Sir:

Prior to examination of the above-referenced application, please amend the application as  
follows:

IN THE SPECIFICATION:

On page 1 of the specification, after the title, insert the following:

--This application is a divisional of U.S. Patent Application Serial No. 09/484,024, filed January  
18, 2000.--

**REMARKS**

The above amendment to the specification has been made in order to include the prior application  
information. Entry of this Preliminary Amendment is respectfully requested.

Respectfully submitted,

MCDERMOTT, WILL & EMERY

Stephen A. Becker  
Registration No. 26,527

600 13<sup>th</sup> Street, N.W.  
Washington, DC 20005-3096  
(202) 756-8000 SAB:BD  
**Date: March 4, 2002**  
Facsimile: (202) 756-8087

20090465-5188007

B1